

2818

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

1
2 EXAMINER: NGUYEN, THINH T.
3 APPLICANTS: JAMIN LING, ET AL.
4 SERIAL NO.: 09/766,798
5 FILED: Jan. 22, 2001
6 FOR: "ELECTROLESS Ni/Pd/Au METALLIZATION
7 STRUCTURE FOR COPPER INTERCONNECT
SUBSTRATE AND METHOD THEREFOR"

Art Unit 2818

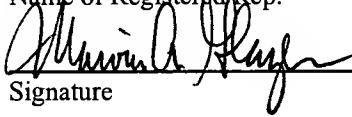
TECHNOLOGY CENTER 2800

APR - 3 2002

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231 on: March 21, 2002
Marvin A. Glazer

Name of Registered Rep.


Signature

March 21, 2002
Date

PETITION FOR ONE-MONTH EXTENSION OF TIME

Honorable Commissioner for Patents
Washington, D.C. 20231

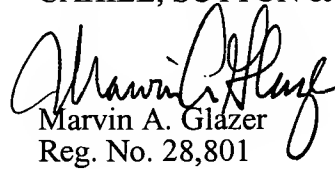
Sir:

It is respectfully requested that the time now set to respond to the Office Action mailed on December 5, 2001, for the above-identified patent application be extended from March 5, 2002, up to and including April 5, 2002.

This Petition is accompanied by an Amendment to the above-referenced patent application.

A check in the amount of One-Hundred Ten Dollars (\$110.00) accompanies this Petition, as required by 37 C.F.R. §1.17(a). Please charge any additional fees required by this paper to Deposit Account No. 03 0088. Two duplicate copies of this Petition are also enclosed.

Respectfully submitted,
CAHILL, SUTTON & THOMAS, P.L.C.


Marvin A. Glazer
Reg. No. 28,801

155 Park One
2141 East Highland Avenue
Phoenix, Arizona 85016
Ph. (602) 956-7000

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